National Semiconductor

August 2000

LMC6082
Precision CMOS Dual Operational Amplifier

General Description

The LMC6082 is a precision dual low offset voltage operational amplifier, capable of single supply operation. Performance characteristics include ultra low input bias current, high voltage gain, rail-to-rail output swing, and an input common mode voltage range that includes ground. These features, plus its low offset voltage, make the LMC6082 ideally suited for precision circuit applications.

Other applications using the LMC6082 include precision full-wave rectifiers, integrators, references, and sample-and-hold circuits.

This device is built with National's advanced Double-Poly Silicon-Gate CMOS process.

For designs with more critical power demands, see the LMC6062 precision dual micropower operational amplifier.

PATENT PENDING

Features

(Typical unless otherwise stated)

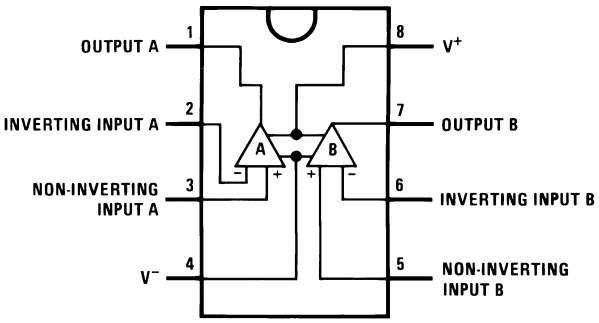
- Low offset voltage: 150 µV
- Operates from 4.5V to 15V single supply
- Ultra low input bias current: 10 fA
- Output swing to within 20 mV of supply rail, 100k load
- Input common-mode range includes V^-
- High voltage gain: 130 dB
- Improved latchup immunity

Applications

- Instrumentation amplifier
- Photodiode and infrared detector preamplifier
- Transducer amplifiers
- Medical instrumentation
- D/A converter
- Charge amplifier for piezoelectric transducers

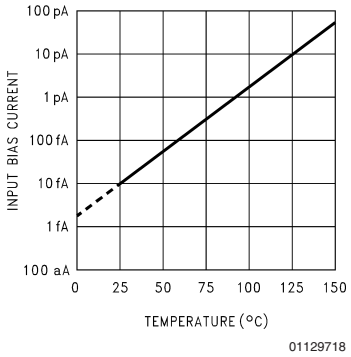
Connection Diagram

8-Pin DIP/SO



Top View

Input Bias Current vs Temperature



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Absolute Maximum Ratings (Note 1)

If Military/Aerospace specified devices are required, please contact the National Semiconductor Sales Office/ Distributors for availability and specifications.

Differential Input Voltage	±Supply Voltage
Voltage at Input/Output Pin	(V^+) +0.3V, (V^-) −0.3V
Supply Voltage ($V^+ - V^-$)	16V
Output Short Circuit to V^+	(Note 11)
Output Short Circuit to V^-	(Note 2)
Lead Temperature (Soldering, 10 Sec.)	260˚C
Storage Temp. Range	−65˚C to +150˚C
Junction Temperature	150˚C
ESD Tolerance (Note 4)	2 kV
Current at Input Pin	±10 mA
Current at Output Pin	±30 mA
Current at Power Supply Pin	40 mA
Power Dissipation	(Note 3)

Operating Ratings (Note 1)

Temperature Range	
LMC6082AM	$-55^\circ C \le T_J \le +125^\circ C$
LMC6082AI, LMC6082I	$-40^\circ C \le T_J \le +85^\circ C$
Supply Voltage	$4.5V \le V^+ \le 15.5V$
Thermal Resistance (θ_{JA}) (Note 12)	
8-Pin Molded DIP	115˚C/W
8-Pin SO	193˚C/W
Power Dissipation	(Note 10)

DC Electrical Characteristics

Unless otherwise specified, all limits guaranteed for T_J = 25˚C. **Boldface** limits apply at the temperature extremes. V^+ = 5V, V^- = 0V, V_{CM} = 1.5V, V_O = 2.5V and R_L > 1M unless otherwise specified.

Symbol	Parameter	Conditions		Typ (Note 5)	LMC6082AM Limit (Note 6)	LMC6082AI Limit (Note 6)	LMC6082I Limit (Note 6)	Units
V_{OS}	Input Offset Voltage			150	350 **1000**	350 **800**	800 **1300**	µV Max
TCV_{OS}	Input Offset Voltage Average Drift			1.0				µV/˚C
I_B	Input Bias Current			0.010	 **100**	 **4**	 **4**	pA Max
I_{OS}	Input Offset Current			0.005	 **100**	 **2**	 **2**	pA Max
R_{IN}	Input Resistance			>10				Tera Ω
CMRR	Common Mode Rejection Ratio	$0V \le V_{CM} \le 12.0V$ $V^+ = 15V$		85	75 **72**	75 **72**	66 **63**	dB Min
+PSRR	Positive Power Supply Rejection Ratio	$5V \le V^+ \le 15V$ $V_O = 2.5V$		85	75 **72**	75 **72**	66 **63**	dB Min
−PSRR	Negative Power Supply Rejection Ratio	$0V \le V^- \le -10V$		94	84 **81**	84 **81**	74 **71**	dB Min
V_{CM}	Input Common-Mode Voltage Range	V^+ = 5V and 15V for CMRR ≥ 60 dB		−0.4	−0.1 **0**	−0.1 **0**	−0.1 **0**	V Max
				$V^+ - 1.9$	$V^+ - 2.3$ $\mathbf{V^+ - 2.6}$	$V^+ - 2.3$ $\mathbf{V^+ - 2.5}$	$V^+ - 2.3$ $\mathbf{V^+ - 2.5}$	V Min
A_V	Large Signal Voltage Gain	R_L = 2 kΩ (Note 7)	Sourcing	1400	400 **300**	400 **300**	300 **200**	V/mV Min
			Sinking	350	180 **70**	180 **100**	90 **60**	V/mV Min
		R_L = 600Ω (Note 7)	Sourcing	1200	400 **150**	400 **150**	200 **80**	V/mV Min
			Sinking	150	100 **35**	100 **50**	70 **35**	V/mV Min

DC Electrical Characteristics (Continued)

Unless otherwise specified, all limits guaranteed for T_J = 25˚C. **Boldface** limits apply at the temperature extremes. V^+ = 5V, V^- = 0V, V_{CM} = 1.5V, V_O = 2.5V and R_L > 1M unless otherwise specified.

Symbol	Parameter	Conditions	Typ (Note 5)	LMC6082AM Limit (Note 6)	LMC6082AI Limit (Note 6)	LMC6082I Limit (Note 6)	Units
V_O	Output Swing	V^+ = 5V	4.87	4.80	4.80	4.75	V
		R_L = 2 kΩ to 2.5V		**4.70**	**4.73**	**4.67**	Min
			0.10	0.13	0.13	0.20	V
				0.19	**0.17**	**0.24**	Max
		V^+ = 5V	4.61	4.50	4.50	4.40	V
		R_L = 600Ω to 2.5V		**4.24**	**4.31**	**4.21**	Min
			0.30	0.40	0.40	0.50	V
				0.63	**0.50**	**0.63**	Max
		V^+ = 15V	14.63	14.50	14.50	14.37	V
		R_L = 2 kΩ to 7.5V		**14.30**	**14.34**	**14.25**	Min
			0.26	0.35	0.35	0.44	V
				0.48	**0.45**	**0.56**	Max
		V^+ = 15V	13.90	13.35	13.35	12.92	V
		R_L = 600Ω to 7.5V		**12.80**	**12.86**	**12.44**	Min
			0.79	1.16	1.16	1.33	V
				1.42	**1.32**	**1.58**	Max
I_O	Output Current	Sourcing, V_O = 0V	22	16	16	13	mA
	V^+ = 5V			**8**	**10**	**8**	Min
		Sinking, V_O = 5V	21	16	16	13	mA
				11	**13**	**10**	Min
I_O	Output Current	Sourcing, V_O = 0V	30	28	28	23	mA
	V^+ = 15V			**18**	**22**	**18**	Min
		Sinking, V_O = 13V	34	28	28	23	mA
		(Note 11)		**19**	**22**	**18**	Min
I_S	Supply Current	Both Amplifiers	0.9	1.5	1.5	1.5	mA
		V^+ = +5V, V_O = 1.5V		**1.8**	**1.8**	**1.8**	Max
		Both Amplifiers	1.1	1.7	1.7	1.7	mA
		V^+ = +15V, V_O = 7.5V		**2**	**2**	**2**	Max

AC Electrical Characteristics

Unless otherwise specified, all limits guaranteed for T_J = 25˚C, **Boldface** limits apply at the temperature extremes. V^+ = 5V, V^- = 0V, V_{CM} = 1.5V, V_O = 2.5V and R_L > 1M unless otherwise specified.

Symbol	Parameter	Conditions	Typ (Note 5)	LMC6082AM Limit (Note 6)	LMC6082AI Limit (Note 6)	LMC6082I Limit (Note 6)	Units
SR	Slew Rate	(Note 8)	1.5	0.8 **0.5**	0.8 **0.6**	0.8 **0.6**	V/µs Min
GBW	Gain-Bandwidth Product		1.3				MHz
ϕ_m	Phase Margin		50				Deg
	Amp-to-Amp Isolation	(Note 9)	140				dB
e_n	Input-Referred Voltage Noise	F = 1 kHz	22				$nV/\sqrt{Hz}$
i_n	Input-Referred Current Noise	F = 1 kHz	0.0002				$pA/\sqrt{Hz}$
T.H.D.	Total Harmonic Distortion	F = 10 kHz, A_V = –10 R_L = 2 kΩ, V_O = 8 V_{PP} ±5V Supply	0.01				%

Note 1: Absolute Maximum Ratings indicate limits beyond which damage to the device may occur. Operating Ratings indicate conditions for which the device is intended to be functional, but do not guarantee specific performance limits. For guaranteed specifications and test conditions, see the Electrical Characteristics. The guaranteed specifications apply only for the test conditions listed.

Note 2: Applies to both single-supply and split-supply operation. Continuous short circuit operation at elevated ambient temperature can result in exceeding the maximum allowed junction temperature of 150˚C. Output currents in excess of ±30 mA over long term may adversely affect reliability.

Note 3: The maximum power dissipation is a function of $T_{J(Max)}$, θ_{JA}, and T_A. The maximum allowable power dissipation at any ambient temperature is $P_D = (T_{J(Max)} - T_A) / \theta_{JA}$.

Note 4: Human body model, 1.5 kΩ in series with 100 pF.

Note 5: Typical values represent the most likely parametric norm.

Note 6: All limits are guaranteed by testing or statistical analysis.

Note 7: V^+ = 15V, V_{CM} = 7.5V and R_L connected to 7.5V. For Sourcing tests, 7.5V ≤ V_O ≤ 11.5V. For Sinking tests, 2.5V ≤ V_O ≤ 7.5V.

Note 8: V^+ = 15V. Connected as Voltage Follower with 10V step input. Number specified is the slower of the positive and negative slew rates.

Note 9: Input referred V^+ = 15V and R_L = 100 kΩ connected to 7.5V. Each amp excited in turn with 1 kHz to produce V_O = 12 V_{PP}.

Note 10: For operating at elevated temperatures the device must be derated based on the thermal resistance θ_{JA} with $P_D = (T_J - T_A)/\theta_{JA}$. All numbers apply for packages soldered directly into a PC board.

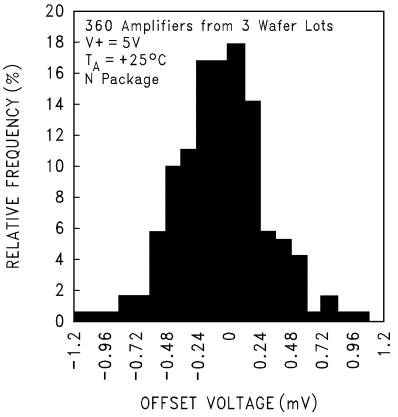
Note 11: Do not connect output to V^+, when V^+ is greater than 13V or reliability will be adversely affected.

Note 12: All numbers apply for packages soldered directly into a PC board.

Typical Performance Characteristics

V_S = ±7.5V, T_A = 25˚C, Unless otherwise specified

Distribution of LMC6082 Input Offset Voltage (T_A = +25˚C)



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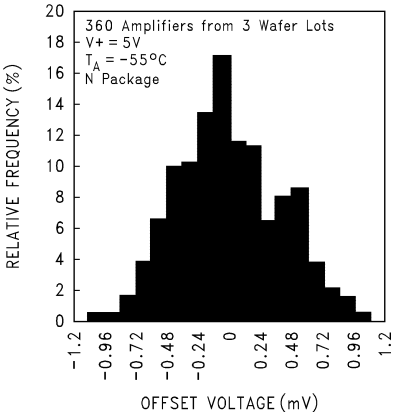
Distribution of LMC6082 Input Offset Voltage (T_A = −55˚C)



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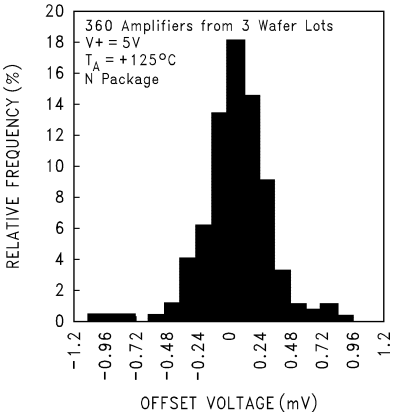
Distribution of LMC6082 Input Offset Voltage (T_A = +125˚C)



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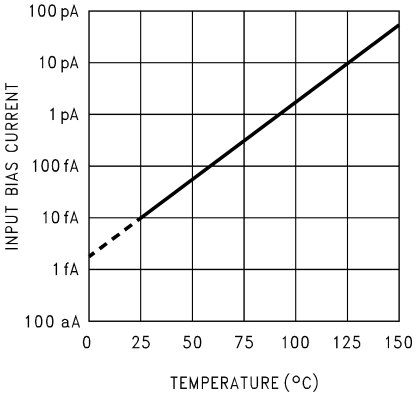
Input Bias Current vs Temperature



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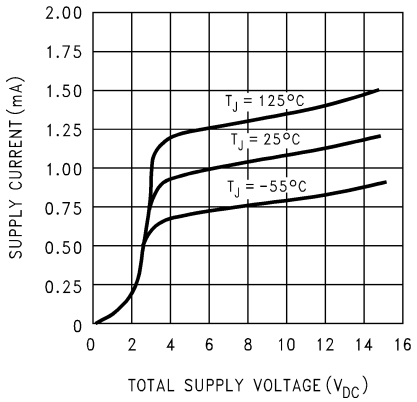
Supply Current vs Supply Voltage



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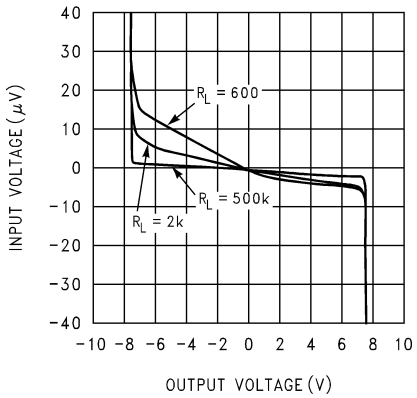
Input Voltage vs Output Voltage



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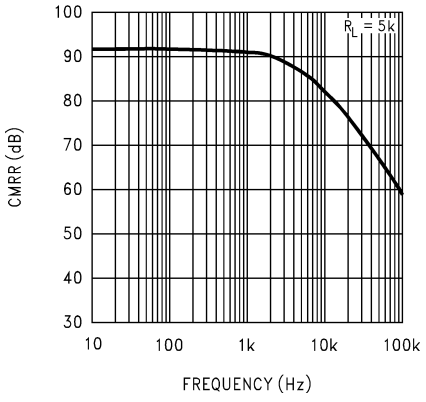
Typical Performance Characteristics V_S = ±7.5V, T_A = 25˚C, Unless otherwise specified (Continued)

Common Mode Rejection Ratio vs Frequency



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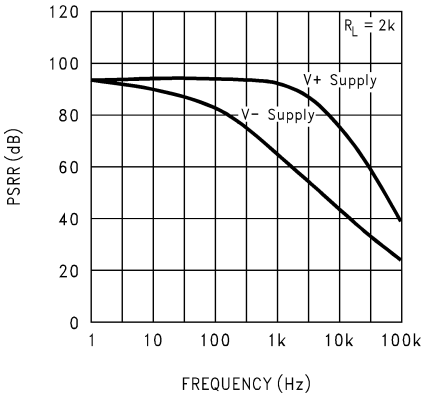
Power Supply Rejection Ratio vs Frequency



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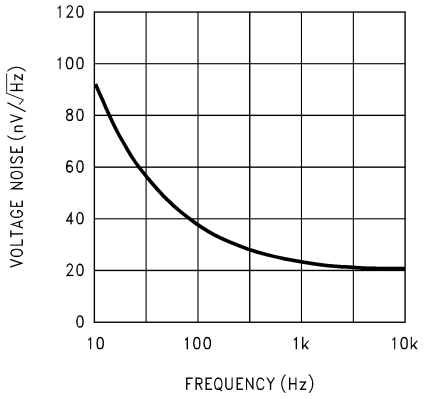
Input Voltage Noise vs Frequency



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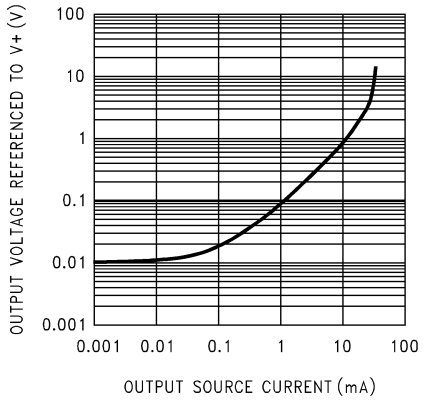
Output Characteristics Sourcing Current



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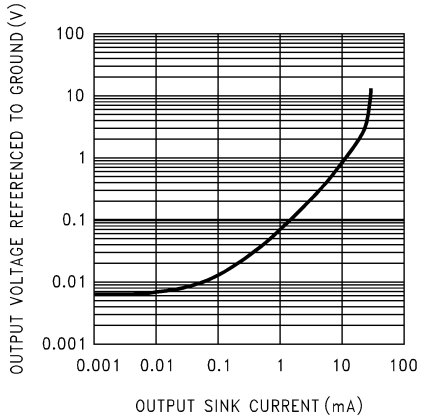
Output Characteristics Sinking Current



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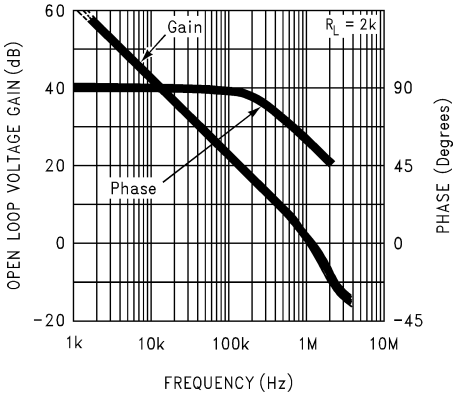
Gain and Phase Response vs Temperature (–55˚C to +125˚C)



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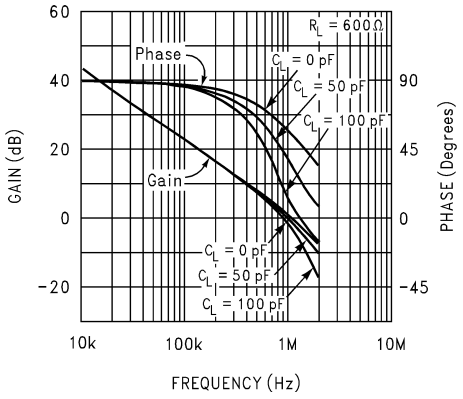
Typical Performance Characteristics V_S = ±7.5V, T_A = 25˚C, Unless otherwise specified (Continued)

Gain and Phase Response vs Capacitive Load with R_L = 600Ω



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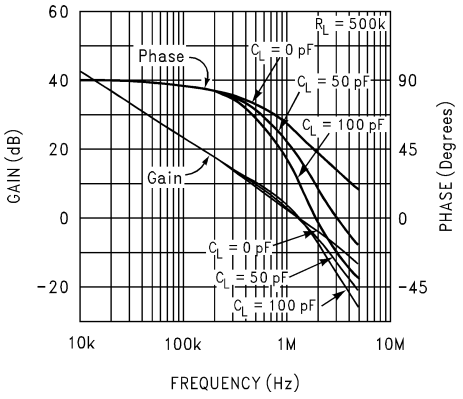
Gain and Phase Response vs Capacitive Load with R_L = 500 kΩ



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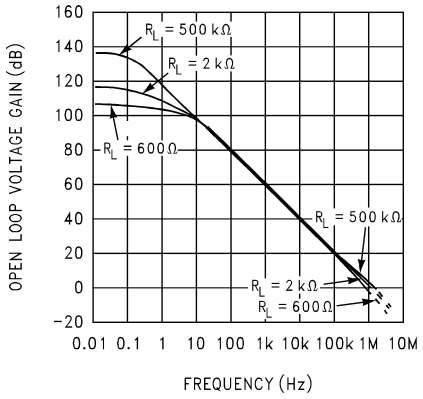
Open Loop Frequency Response



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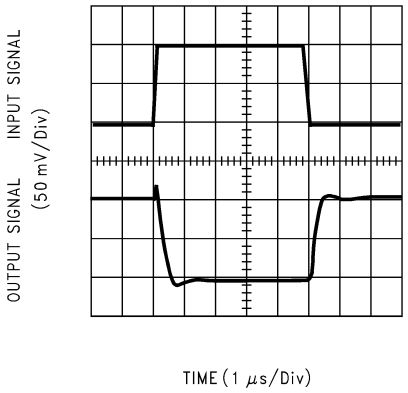
Inverting Small Signal Pulse Response



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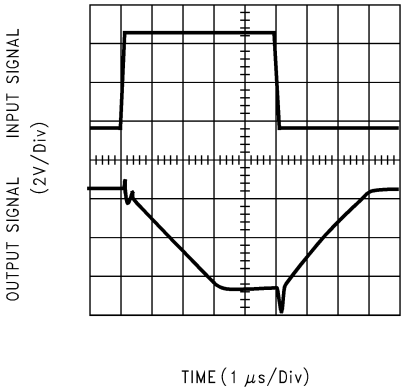
Inverting Large Signal Pulse Response



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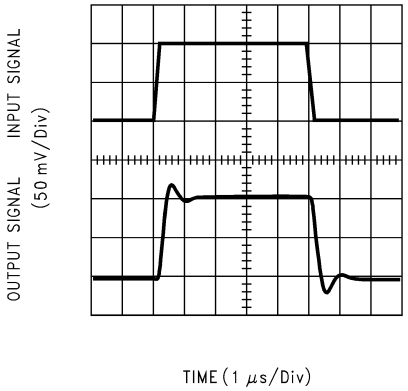
Non-Inverting Small Signal Pulse Response



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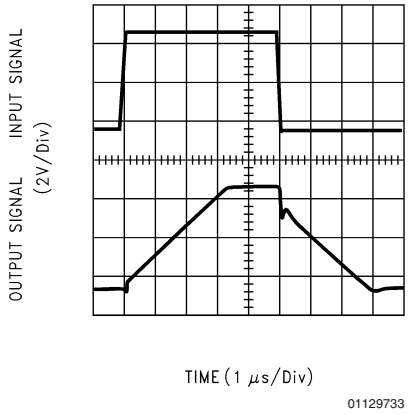
Typical Performance Characteristics V_S = ±7.5V, T_A = 25˚C, Unless otherwise specified (Continued)

Non-Inverting Large Signal Pulse Response



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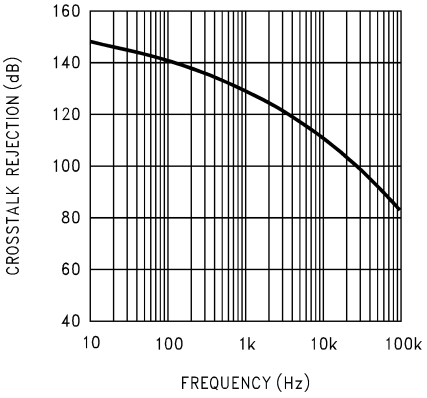
Crosstalk Rejection vs Frequency



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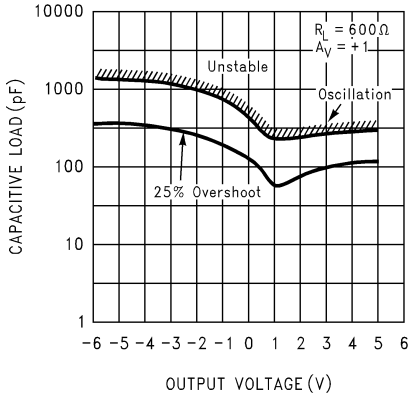
Stability vs Capacitive Load, R_L = 600Ω



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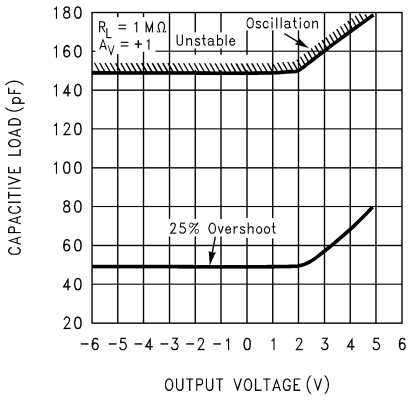
Stability vs Capacitive Load R_L = 1 MΩ



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Applications Hints

AMPLIFIER TOPOLOGY

The LMC6082 incorporates a novel op-amp design topology that enables it to maintain rail to rail output swing even when driving a large load. Instead of relying on a push-pull unity gain output buffer stage, the output stage is taken directly from the internal integrator, which provides both low output impedance and large gain. Special feed-forward compensation design techniques are incorporated to maintain stability over a wider range of operating conditions than traditional micropower op-amps. These features make the LMC6082 both easier to design with, and provide higher speed than products typically found in this ultra-low power class.

COMPENSATING FOR INPUT CAPACITANCE

It is quite common to use large values of feedback resistance for amplifiers with ultra-low input current, like the LMC6082.

Although the LMC6082 is highly stable over a wide range of operating conditions, certain precautions must be met to achieve the desired pulse response when a large feedback resistor is used. Large feedback resistors and even small values of input capacitance, due to transducers, photodiodes, and circuit board parasitics, reduce phase margins.

When high input impedances are demanded, guarding of the LMC6082 is suggested. Guarding input lines will not only reduce leakage, but lowers stray input capacitance as well. (See *Printed-Circuit-Board Layout for High Impedance Work).*

The effect of input capacitance can be compensated for by adding a capacitor, C_f, around the feedback resistors (as in *Figure 1*) such that:

$$\frac{1}{2\pi R_1 C_{IN}} \geq \frac{1}{2\pi R_2 C_f}$$

or

$$R_1\ C_{IN} \leq R_2\ C_f$$

Since it is often difficult to know the exact value of C_{IN}, C_f can be experimentally adjusted so that the desired pulse response is achieved. Refer to the LMC660 and LMC662 for a more detailed discussion on compensating for input capacitance.

Applications Hints (Continued)

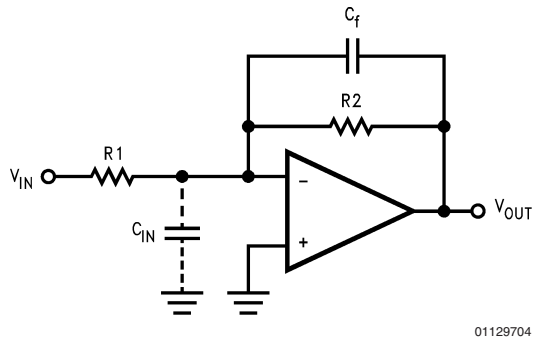


FIGURE 1. Cancelling the Effect of Input Capacitance

CAPACITIVE LOAD TOLERANCE

All rail-to-rail output swing operational amplifiers have voltage gain in the output stage. A compensation capacitor is normally included in this integrator stage. The frequency location of the dominant pole is affected by the resistive load on the amplifier. Capacitive load driving capability can be optimized by using an appropriate resistive load in parallel with the capacitive load (see typical curves).

Direct capacitive loading will reduce the phase margin of many op-amps. A pole in the feedback loop is created by the combination of the op-amp's output impedance and the capacitive load. This pole induces phase lag at the unity-gain crossover frequency of the amplifier resulting in either an oscillatory or underdamped pulse response. With a few external components, op amps can easily indirectly drive capacitive loads, as shown in *Figure 2*.

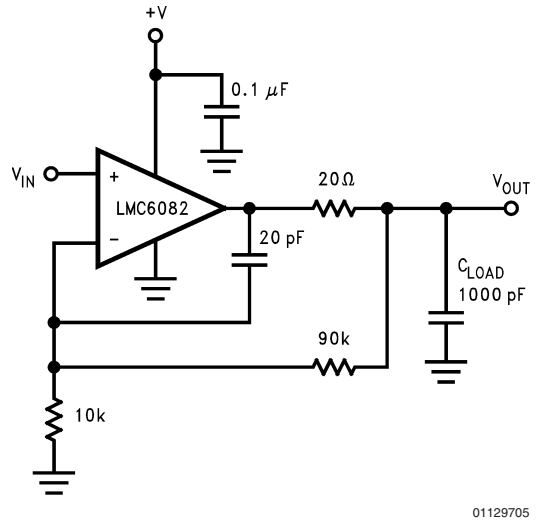


FIGURE 2. LMC6082 Noninverting Gain of 10 Amplifier, Compensated to Handle Capacitive Loads

In the circuit of *Figure 2*, R1 and C1 serve to counteract the loss of phase margin by feeding the high frequency component of the output signal back to the amplifier's inverting input, thereby preserving phase margin in the overall feedback loop.

Capacitive load driving capability is enhanced by using a pull up resistor to V^+ *Figure 3*. Typically a pull up resistor conducting 500 µA or more will significantly improve capacitive load responses. The value of the pull up resistor must be determined based on the current sinking capability of the amplifier with respect to the desired output swing. Open loop gain of the amplifier can also be affected by the pull up resistor (see Electrical Characteristics).

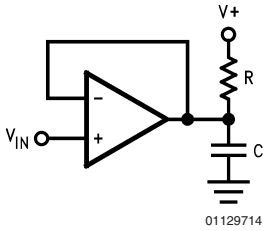


FIGURE 3. Compensating for Large Capacitive Loads with a Pull Up Resistor

PRINTED-CIRCUIT-BOARD LAYOUT FOR HIGH-IMPEDANCE WORK

It is generally recognized that any circuit which must operate with less than 1000 pA of leakage current requires special layout of the PC board. When one wishes to take advantage of the ultra-low bias current of the LMC6082, typically less than 10 fA, it is essential to have an excellent layout. Fortunately, the techniques of obtaining low leakages are quite simple. First, the user must not ignore the surface leakage of the PC board, even though it may sometimes appear acceptably low, because under conditions of high humidity or dust or contamination, the surface leakage will be appreciable.

To minimize the effect of any surface leakage, lay out a ring of foil completely surrounding the LMC6082's inputs and the terminals of capacitors, diodes, conductors, resistors, relay terminals, etc. connected to the op-amp's inputs, as in *Figure 4*. To have a significant effect, guard rings should be placed on both the top and bottom of the PC board. This PC foil must then be connected to a voltage which is at the same voltage as the amplifier inputs, since no leakage current can flow between two points at the same potential. For example, a PC board trace-to-pad resistance of $10^{12}\Omega$, which is normally considered a very large resistance, could leak 5 pA if the trace were a 5V bus adjacent to the pad of the input. This would cause a 100 times degradation from the LMC6082's actual performance. However, if a guard ring is held within 5 mV of the inputs, then even a resistance of $10^{11}\Omega$ would cause only 0.05 pA of leakage current. See *Figure 5* for typical connections of guard rings for standard op-amp configurations.

Applications Hints (Continued)

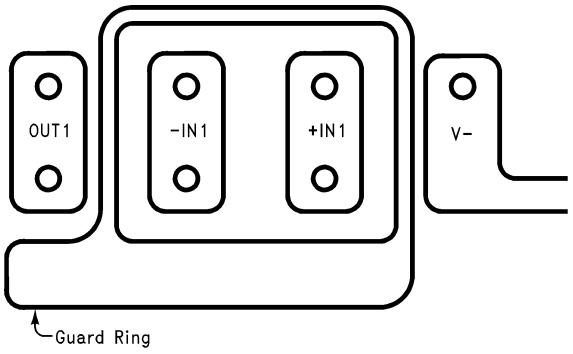
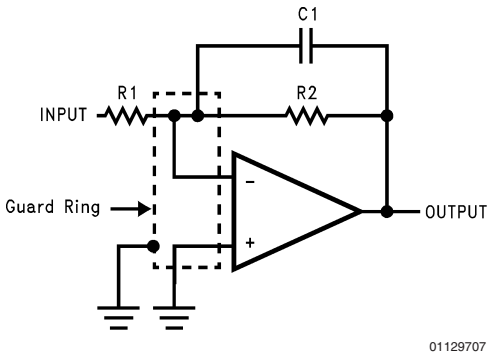
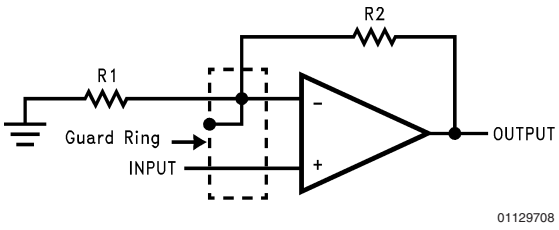


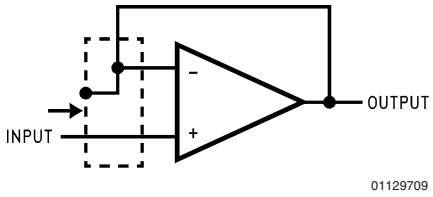
FIGURE 4. Example of Guard Ring in P.C. Board Layout



Inverting Amplifier



Non-Inverting Amplifier



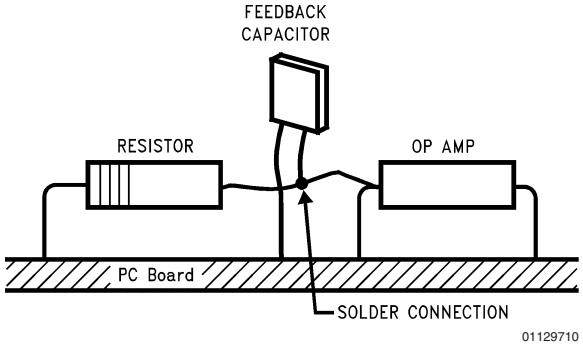
Follower

FIGURE 5. Typical Connections of Guard Rings

The designer should be aware that when it is inappropriate to lay out a PC board for the sake of just a few circuits, there is another technique which is even better than a guard ring on a PC board: Don't insert the amplifier's input pin into the board at all, but bend it up in the air and use only air as an insulator. Air is an excellent insulator. In this case you may have to forego some of the advantages of PC board construction, but the advantages are sometimes well worth the effort of using point-to-point up-in-the-air wiring. See *Figure 6*.

Latchup

CMOS devices tend to be susceptible to latchup due to their internal parasitic SCR effects. The (I/O) input and output pins look similar to the gate of the SCR. There is a minimum current required to trigger the SCR gate lead. The LMC6062 and LMC6082 are designed to withstand 100 mA surge current on the I/O pins. Some resistive method should be used to isolate any capacitance from supplying excess current to the I/O pins. In addition, like an SCR, there is a minimum holding current for any latchup mode. Limiting current to the supply pins will also inhibit latchup susceptibility.



(Input pins are lifted out of PC board and soldered directly to components. All other pins connected to PC board).

FIGURE 6. Air Wiring

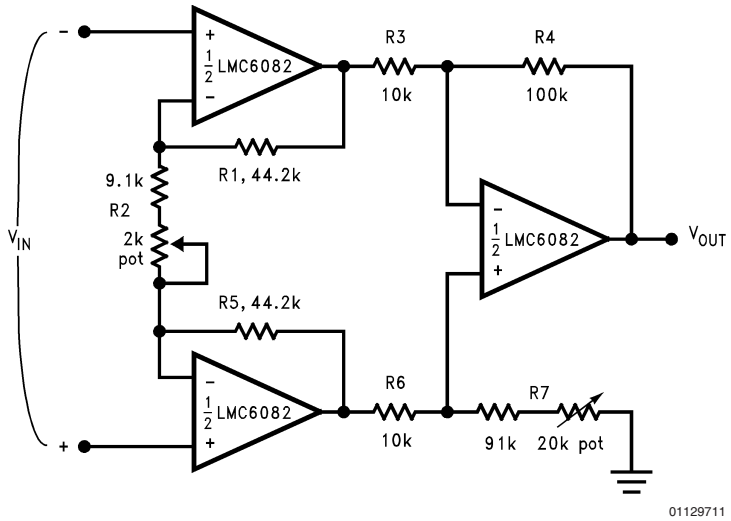
Typical Single-Supply Applications

($V^+ = 5.0\ V_{DC}$)

The extremely high input impedance, and low power consumption, of the LMC6082 make it ideal for applications that require battery-powered instrumentation amplifiers. Examples of these types of applications are hand-held pH probes, analytic medical instruments, magnetic field detectors, gas detectors, and silicon based pressure transducers.

Figure 7 shows an instrumentation amplifier that features high differential and common mode input resistance ($>10^{14}\Omega$), 0.01% gain accuracy at A_V = 1000, excellent CMRR with 1 kΩ imbalance in bridge source resistance. Input current is less than 100 fA and offset drift is less than 2.5 μV/°C. R_2 provides a simple means of adjusting gain over a wide range without degrading CMRR. R_7 is an initial trim used to maximize CMRR without using super precision matched resistors. For good CMRR over temperature, low drift resistors should be used.

Typical Single-Supply Applications (Continued)



If $R_1 = R_5$, $R_3 = R_6$, and $R_4 = R_7$; then

$$\frac{V_{OUT}}{V_{IN}} = \frac{R_2 + 2R_1}{R_2} \times \frac{R_4}{R_3}$$

$\therefore A_V \approx 100$ for circuit shown (R_2 = 9.822k).

FIGURE 7. Instrumentation Amplifier

Typical Single-Supply Applications

($V^+ = 5.0\ V_{DC}$)

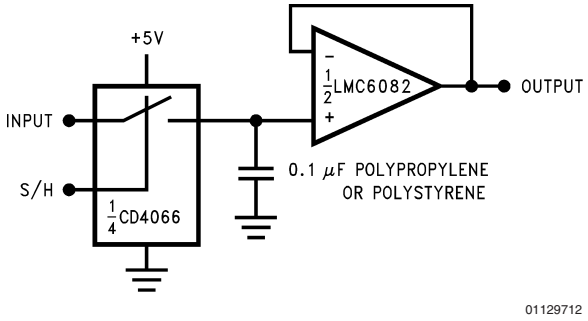


FIGURE 8. Low-Leakage Sample and Hold

Typical Single-Supply Applications (V^+ = 5.0 V_{DC}) (Continued)

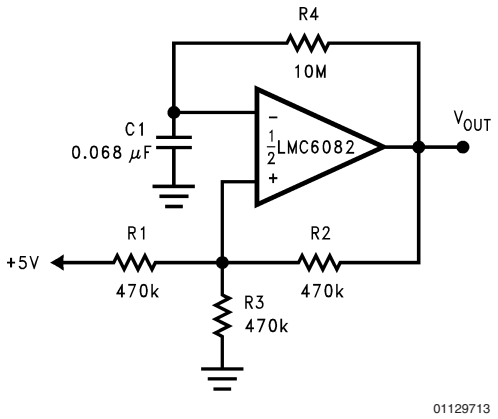
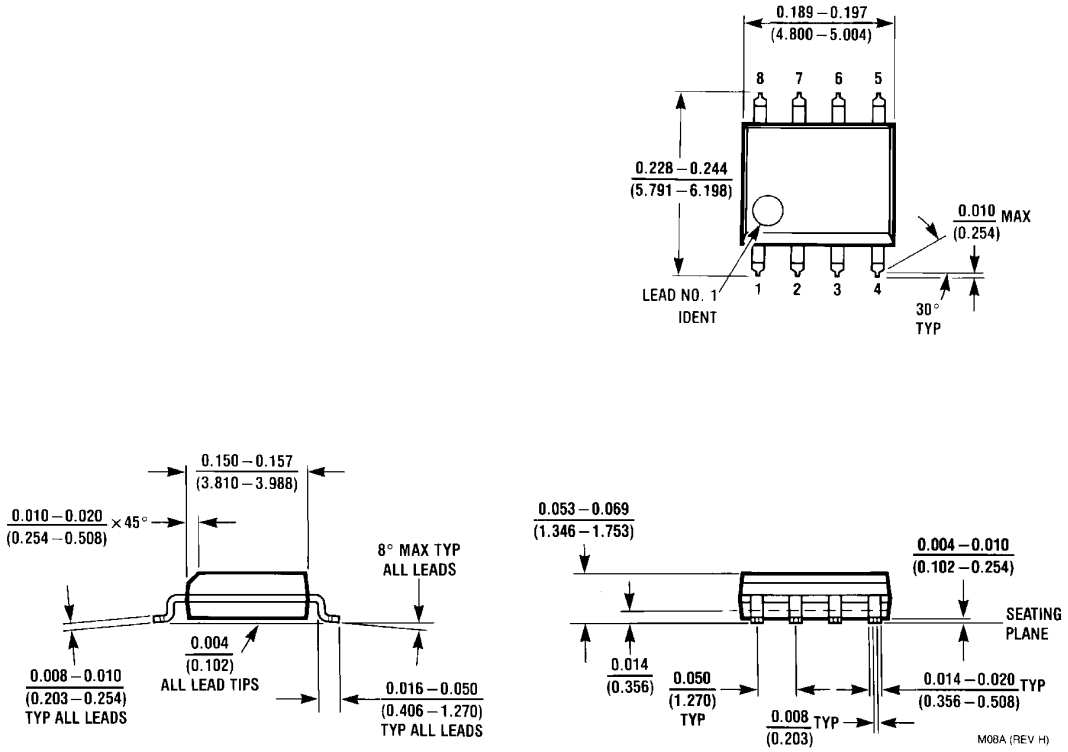


FIGURE 9. 1 Hz Square Wave Oscillator

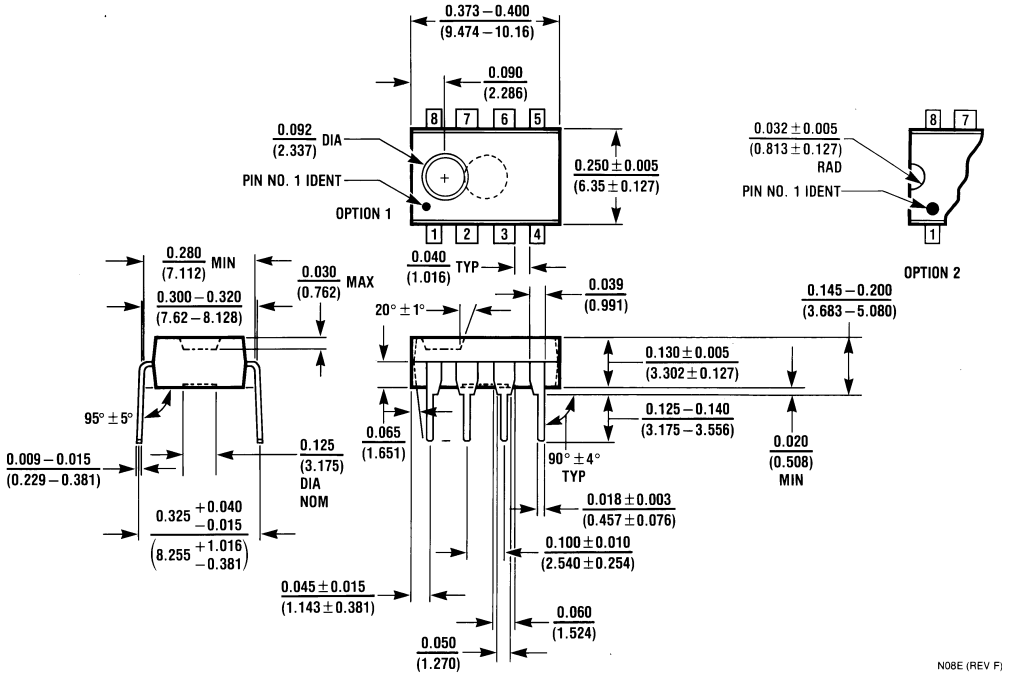
Ordering Information

Package	Temperature Range		NSC Drawing	Transport Media
	Military −55˚C to +125˚C	Industrial −40˚C to +85˚C		
8-Pin Molded DIP		LMC6082AIN LMC6082IN	N08E	Rail
8-Pin Small Outline		LMC6082AIM, LMC6082AIMX, LMC6082IM, LMC6082IMX	M08A	Rail Tape and Reel
For MIL-STD-883C qualified products, please contact your local National Semiconductor Sales Office or Distributor for availability and specification information.				

Physical Dimensions inches (millimeters) unless otherwise noted



8-Pin Small Outline Package
Order Number LMC6082AIM, LMC6082AIMX, LMC6082IM or LMC6082IMX
NS Package Number M08A



8-Pin Molded Dual-In-Line Package
Order Number LMC6082AIN or LMC6082IN
NS Package Number N08E

Notes

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